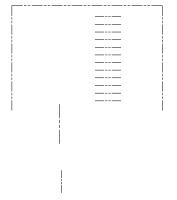


## NOTES

- 1. MATERIALS: HOUSING LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0
  TERMINALS HIGH PERFORMANCE COPPER ALLOY
- 2. FINISH: 30MN MIN SELECTIVE GOLD IN CONTACT AREA, SELECTIVE TIN ON PCB TAILS. NICKEL OVERALL.
- 3. REFER TO MOLEX PRODUCT SPEC PS-76060-999 FOR PERFORMANCE SPECIFICATIONS AND ADDITIONAL PCB INFORMATION.
- 4. EACH SIGNAL WAFER CONTAINS 2 COLUMNS OF TERMINALS.
- 5. PRODUCT IS PACKAGED PER PK-70873-610.
- 6. THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002.
- 7. REFER TO MOLEX SALES DRAWING SD-76155-002 FOR THE MATING HEADERS AND SD-76500-004 FOR THE MATING RAM CONNECTORS.
- 8. REFER TO MOLEX PCB ROUTING GUIDE AS-76060-990 FOR ANTIPAD AND ROUTING RECOMMENDATIONS.
- PART NUMBER 76160-3120 SHOWN ON DRAWING. KEYING FEATURES WILL CHANGE WITH COLUMN SIZE.
- 10, MINIMUM BOARD THICKNESS IS 1,00 mm FOR COMPLIANT PIN FUNCTIONALITY.
- 11.WHEN USING MOLEX SUPPLIED #2-32 SCREW 73726-0000 (9.50mm ±0.38

THREADABLE SCREW LENGTH). THE MAXIMUM BOARD THICKNESS I



molex